

Attention: Derek Woods

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants: Beaman et al.

Date: Oct. 7, 2003

Serial Number 08/756,830

Group Art Unit: 2858

Filed: November 20, 1996

Examiner: V. Nguyen

Docket: YOR919990023US2

For: A HIGH DENSITY INTEGRAL TEST PROBE AND FABRICATION METHOD

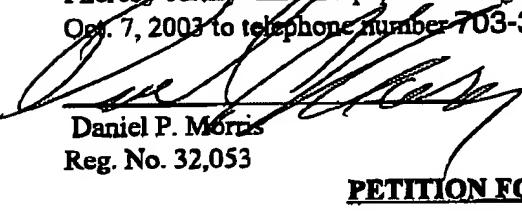
Commissioner of Patents and Trademarks

Washington, D.C. 20231

Sir:

**CERTIFICATE OF FACSIMILE TRANSMISSION**

I hereby certify that this paper is being facsimile transmitted to the U.S. Patent and Trademark Office on Oct. 7, 2003 to telephone number 703-308-6916 on the date shown above.

  
Daniel P. Morris  
Reg. No. 32,053

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OCT 07 2003

PETITIONS OFFICE

**PETITION FOR CORRECTED FILING RECEIPT**

**AND**

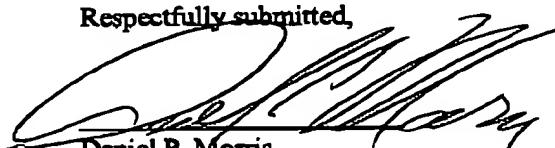
**REQUEST FOR CORRECTION OF THE CLAIM OF PRIORITY UNDER 37 CFR 1.78**

Applicants petition to correct the filing receipt of the above-identified application to read

This application is a continuation of US Application 08/425,543 filed on 04/20/1995 now abandoned and is a continuation in part of US Application 08/300620 filed on 02-Sep-1994 now US patent 5531022 issued on 02-Jul-1996 which is a division of US Application 07/963346 filed on 19-Oct-1992 now US patent 5371654 issued on 06-Dec-1994.

Please charge deposit account 09-0468 any fee necessary to enter this paper. Since this application was filed before November 29, 2000, no fee should be necessary to enter this paper.

Respectfully submitted,

  
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Reg. No. 32,053

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